MECHANICAL DATA

RGY (S-PVQFN-N14) PLASTIC QUAD FLATPACK NO-LEAD

Pin 1 Index Area
Top and Bottom

A

1.00
0.80

0.05
0.00
Sealing Height

0.20 Nominal
Lead Frame

Sealing Plane

NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M–1994.
B. This drawing is subject to change without notice.
C. OFN (Quad Flatpack No-Lead) package configuration.
D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.

⚠ Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated.

The Pin 1 identifiers are either molded, marked, or metal feature.
G. Package complies to JEDEC MO-241 variation BA.
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